#### 505725554 10/16/2019

**EPAS ID: PAT5772366** 

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

**SUBMISSION TYPE: NEW ASSIGNMENT NATURE OF CONVEYANCE: ASSIGNMENT** 

#### **CONVEYING PARTY DATA**

Name	Execution Date
GUAN HUEI SEE	09/25/2019
PRAYUDI LIANTO	09/25/2019
YU GU	09/27/2019

### **RECEIVING PARTY DATA**

Name:	APPLIED MATERIALS SINGAPORE TECHNOLOGY PTE. LTD.	
Street Address:	8 UPPER CHANGI ROAD NORTH	
Internal Address:	APPLIED MATERIALS BUILDING	
City:	SINGAPORE	
State/Country:	SINGAPORE	
Postal Code:	506906	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16579723

### **CORRESPONDENCE DATA**

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MOSER TABOADA/ALAN TABOADA **Correspondent Name:** 

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ATTORNEY DOCKET NUMBER:	APPM24486US2
NAME OF SUBMITTER:	ALAN TABOADA
SIGNATURE:	/ALAN TABOADA/
DATE SIGNED:	10/16/2019

**Total Attachments: 2** 

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> **PATENT REEL: 050735 FRAME: 0272** 505725554

#### ASSIGNMENT FOR APPLICATION FOR PATENT

#### WHEREAS:

Names and Addresses of Inventors:

1) GUAN HUEI SEE Blk 662 Yishun Ave. 4 #07-251 Singapore 760662

#### PRAYUDI LIANTO

620 Bukit-Batok Central #18-522 116B Jalan Teriteran #13-551
Singapore 650620 Singapore 322116
Singapore

3) YU GU Apt Blk 354b Admiralty Drive #06-252, Singapore 752354

(hereinafter referred to as Assignors), have invented a certain invention entitled:

# METHODS OF THINNING SILICON ON EPOXY MOLD COMPOUND FOR RADIO FREQUENCY (RF) APPLICATIONS

for which we have filed an application for a Patent of the United States on September 23, 2019, Serial No. 16/579,723, which claims priority to a provisional application filed September 24, 2018, Serial No. 62/735,581; and

WHEREAS, Applied Materials Singapore Technology Pte. Ltd., a company organized under the laws of Singapore, having a place of business at 8 Upper Changi Road North, Applied Materials Building, Singapore 506906 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignor, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all 926122 1

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Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.
- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

25 Sept 2019 (DATE)

(DATE)

**GUAN HUEI SEE** 

PRAYUDI LIANTO

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